CUSTOMER DRAWING



Due du et	P	CMA			
Name	L max	øA min	øB min	Range	
D-1744-05	30.15 (1.187)	1.9 (0.075)	2.4 (0.095)	350 to 2000	
D-1744-06	30.15 (1.187)	2.8 (0.110)	3.15 (0.125)	2000 to 4000	
D-1744-07	30.15 (1.187)	4.6 (0.180)	5.1 (0.200)	4000 to 10000	
D-1744-08	30.15 (1.187)	7.11 (0.280)	7.62 (0.300)	10000 to 13000	

MATERIALS

1. INSULATION SLEEVE: Heat-shrinkable, transparent blue, radiation cross-linked polyvinylidene fluoride.

- 2. SOLDER PREFORM WITH FLUX:
 - SOLDER: TYPE Sn63 per ANSI/J-STD-006.
 - FLUX: TYPE ROM1 per ANSI/J-STD-004.
- 3. MELTABLE RING: Thermally stabilized thermoplastic. Color: blue.
- 4. MELTABLE RING: Thermally stabilized thermoplastic. Color: gray.

APPLICATION

- 1. These parts are designed to provide an environment resistant in-line splice in wires having nickel-plated conductors and insulation rated for at least 125°C.
- 2. These parts conform to National Aerospace Standard NAS-1744. When properly installed, they will meet the performance requirements of Tyco Electronics/Raychem RT-1404 and NAS-1747 for splices.
- 3. Part selection: Determine total CMA of wires to be spliced and select appropriate sleeve. Splice should contain no more than 3 wires per side.
- 4. Wire is to be stripped to exposed 12.5 ± 1.5 (0.500 ± 0.060) of conductor.
- 5. Parts may be installed using Tyco Electronics/Raychem approved convection or infrared heating tool. Tools must be equipped with a suitable reflector. For detailed assembly instructions, see Tyco Electronics/Raychem RPIP-850-00.
- 6. Temperature range: -55°C to +150°C.

<i>≡<u></u><u>⊺</u><u></u></i>			Raychen	TITLE: SOLDERSLEEVE WIRE SPLICE					
Unless otherwise specified dimensions are in millimeters.			DOCUMENT NO.:						
[Inches dimensions are shown in brackets]				D-1744-05/-06/-07/-08					
TOLERANCES:	ANC	GLES: N/A	TE Connectivity reserves the right to amend						
0.00 N/A			this drawing at any time.	his drawing at any time. Users should evaluate		Revision:		Issue Date:	
0.0 N/A 0 N/A	ROU	GHNESS IN	the suitability of the product for their application		4		April 2020		
DRAWN BY: M. FOROND	AWN BY: AWN BY: CAGE CODE: DATE: 20-May-03 ECO: ECO		20-004960	SCALE: None	SIZE: A	SHEET: 1 of 1			
Print Date: 9-Apr-20 If this document is printed it becomes uncontrolled. Check for the latest revision.									

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